

07-21-1999

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

101098205

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Tetsu Ohwada
Moriyasu Miyazaki
Kazuhiro MukaiAdditional name(s) of conveying
party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name Mitsubishi Denki Kabushiki Kaisha

Internal Address: _____

Street Address: 2-3, Marunouchi 2-chomeChiyoda-kuCity TokyoCountry Japan ZIP 100-8310

Additional name(s) & addresses(es) attached?

☐ Yes ☒ No

3. Name of Conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____Execution Date: July 7, 1999

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:
July 7, 1999

A. Patent Application No.(s)

B. Patent No.(s)

09/350905

Additional numbers attached? ☐ Yes ☒ No5. Name and address of party to whom correspondence
concerning document should be mailed:Name: Vincent M. DeLucaInternal Address: Rothwell, Figg, Ernst & KurzSuite 701 EastStreet Address: 555 13th Street, N.W.City: WashingtonState: D.C. Zip 200046. Total number of applications
and patents involved: 17. Total fee (37 CFR 3.41): . . . \$ 40.00☒ Enclosed☐ Authorized to be charged to deposit account

8. Deposit account number:

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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a
True copy of the original document.*Vincent M. DeLuca

Name of Person Signing

Vincent M DeLuca

Signature

7/12/99

Date

Total number of pages including cover sheet, attachments and documents: 2

ASSIGNMENT OF PATENT APPLICATION

WHEREAS, I/we Tetsu OHWADA, a citizen of Japan,
First Named Inventor, if any
 residing at c/o MITSUBISHI DENKI KABUSHIKI KAISHA,
2-3, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-8310 Japan,
Address

Moriyasu MIYAZAKI, a citizen of Japan,
Second named Inventor, if any
 residing at c/o MITSUBISHI DENKI KABUSHIKI KAISHA,
2-3, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-8310 Japan,
Address

Kazuhiro MUKAI, a citizen of Japan,
Third Named Inventor, if any
 residing at c/o MITSUBISHI DENKI KABUSHIKI KAISHA,
2-3, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-8310 Japan,
Address

_____, a citizen of _____,
Fourth Named Inventor, if any
 residing at _____,
Address

ASSIGNOR(S), am/are the inventor(s) of an invention in (insert title) "LOW-PASS FILTER"

for which I/we have executed an application for Letters Patent of the United States,

[X] of even date herewith;

(Check One) [] U.S. Serial Number _____ filed _____;
 [] International Application No. PCT/ _____ filed _____;

and

WHEREAS, mitsubishi denki kabushiki kaisha of 2-3, Marunouchi 2-chome,
Assignee Citizenship or Corporate Situs Address
Chiyoda-ku, Tokyo 100-8310 Japan,
 ASSIGNEE, is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me/us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I/we, the said ASSIGNEE(S) have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said invention, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reexamination certificates, reissues and extensions thereof, and I/we hereby authorize and request the Commissioner of Patents of the United States, to issue all Letters Patent for said invention to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I/WE HEREBY covenant that I/we have the full right to convey the entire interest herein assigned, and that I/we have not executed, and will not execute, any agreement in conflict herewith.

AND I/WE HEREBY further covenant and agree that I/we will communicate to said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me/us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention at the expense of the ASSIGNEE.

IN TESTIMONY WHEREOF, I/we hereunto set my/our hand(s) and seal(s) the day and year set opposite my/our signature(s).

<u>Tetsu Ohwada</u>	<u>Tetsu OHWADA</u>	L.S.	Date <u>July 7</u> , 1999
<u>Moriyasu Miyazaki</u>	<u>Moriyasu MIYAZAKI</u>	L.S.	Date <u>July 7</u> , 1999
<u>Kazuhiro Mukai</u>	<u>Kazuhiro MUKAI</u>	L.S.	Date <u>July 7</u> , 1999
		L.S.	Date _____, 19__

Witness:

_____	_____
Name	Date
_____	_____
Name	Date

Foreign Inventor Sole/Joint Assignment
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